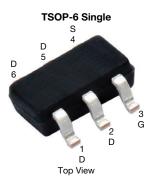


# Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET



Marking code: BD

PRODUCT SUMMARY						
V <sub>DS</sub> (V)+	-30					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.165					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.276					
Q <sub>g</sub> typ. (nC)	2.4					
I <sub>D</sub> (A) <sup>a</sup>	-3.4					
Configuration	Single					

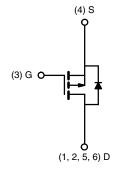
#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



#### **APPLICATIONS**

- Mobile computing
  - Load switch
  - DC/DC converters



P-Channel MOSFET

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3453DV-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		-3.4		
O-ation	T <sub>C</sub> = 70 °C		-2.7		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-2.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		-2 <sup>b, c</sup>	А	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-6		
Continuous autorio dia da comuna	T <sub>C</sub> = 25 °C		-2.5		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-1.3 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		3		
Maximum power dissipation	T <sub>C</sub> = 70 °C	_	1.9	W	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.6 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		1 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, d	t ≤ 5 s	$R_{thJA}$	65	78	°C/W		
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	35	42	C/VV		

#### Notes

- a. Based on T<sub>C</sub> = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 110 °C/W



# Vishay Siliconix

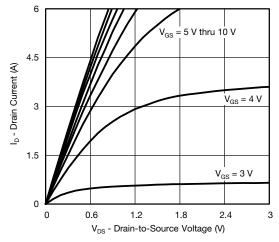
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS			MAX.	UNIT
Static						•
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 A	-	-20	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	3.8	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.2	-	-2.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V	-	-	-1	μA
Zero gate voltage drain current		V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85 °C	-	-	-10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-6	-	-	Α
Due in account on atota and interest 2	_	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -2.5 A	-	0.137	0.165	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$	-	0.230	0.276	Ω
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = -15 \text{ V}, I_D = -2.5 \text{ A}$	-	3	-	S
Dynamic <sup>b</sup>						•
Input capacitance	C <sub>iss</sub>		-	155	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	35	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	25	-	1
Total gate charge	Qg	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	-	4.5	6.8	
			-	2.4	3.6	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.5 \text{ A}$	-	1.2	=.	nC
Gate-drain charge	Q <sub>gd</sub>		-	0.8	=.	
Gate resistance	$R_g$	f = 1 MHz	1.5	7.3	14.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	4	8	
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 7.5 $\Omega$	-	9	18	1
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -2 A, $V_{GEN}=$ -10 V, $R_g=$ 1 $\Omega$	-	11	18	1
Fall time	t <sub>f</sub>		-	7	14	1
Turn-on delay time	t <sub>d(on)</sub>		-	33	50	ns -
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 7.5 $\Omega$	-	21	32	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -2$ A, $V_{GEN} = -4.5$ V, $R_g = 1$ $\Omega$	-	10	20	
Fall time	t <sub>f</sub>		-	9	18	
<b>Drain-Source Body Diode Characteristic</b>	cs			1		
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-2.5	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	-6	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -2 A	_	-0.84	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	14	21	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -2 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	7	14	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25  ^{\circ}{\rm C}$	-	10	-	_
· · · · · · · · · · · · · · · · · · ·	α	· · · · · · · · · · · · · · · · · · ·				ns

#### Notes

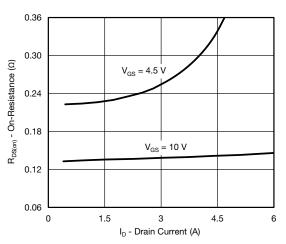
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

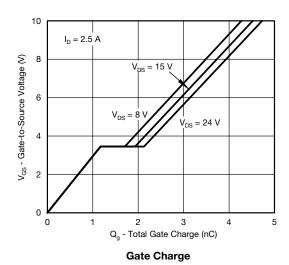


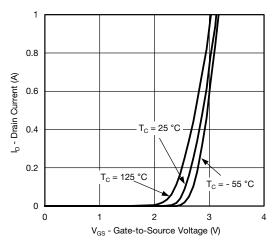


#### **Output Characteristics**

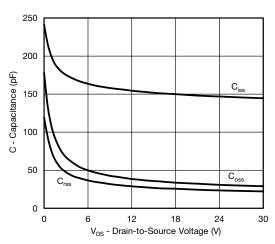


On-Resistance vs. Drain Current and Gate Voltage

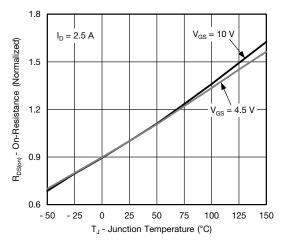




**Transfer Characteristics** 

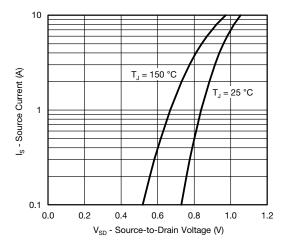


#### Capacitance

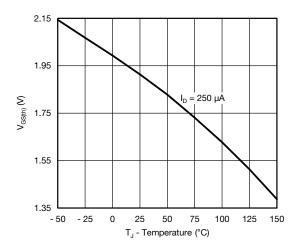


On-Resistance vs. Junction Temperature

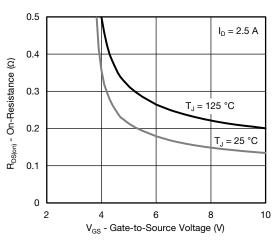




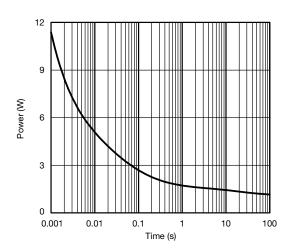
#### Source-Drain Diode Forward Voltage



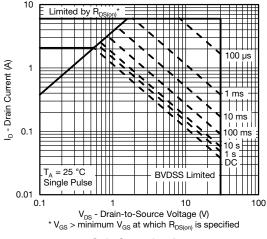
**Threshold Voltage** 



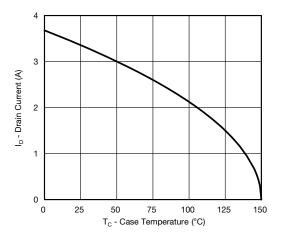
On-Resistance vs. Gate-to-Source Voltage



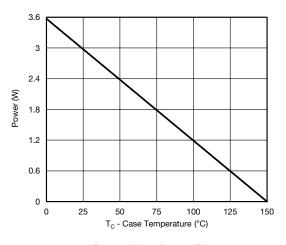
Single Pulse Power



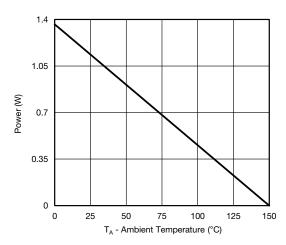




#### Current Derating a





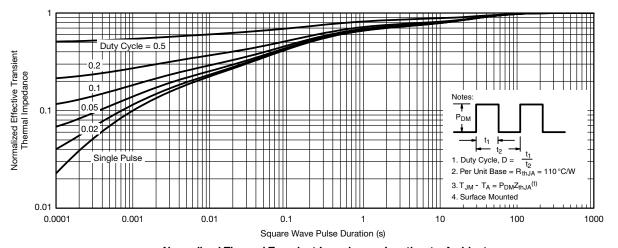


Power, Junction-to-Ambient

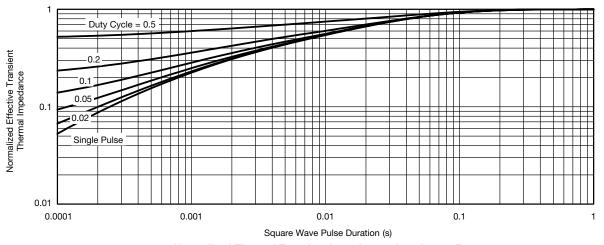
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

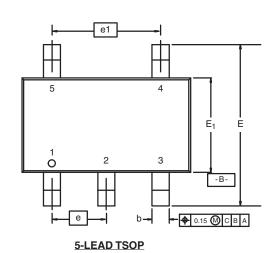
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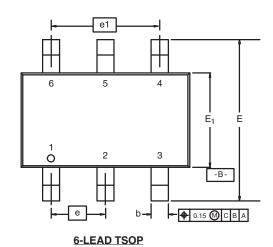


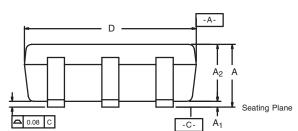


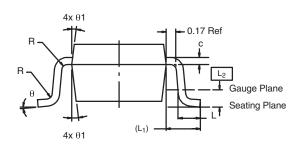
TSOP: 5/6-LEAD

**JEDEC Part Number: MO-193C** 









	MIL	LIMETER	RS	INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004	
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L <sub>1</sub>	0.60 Ref			0.024 Ref			
L <sub>2</sub>	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ1		7° Nom		7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

Document Number: 71200 18-Dec-06

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